

SMDA05C Series

Product Preview

Bi-directional TVS Array for High-Speed Data Line Protection

The SMDA05C transient voltage suppressor series is designed to protect equipment attached to up to four high speed communication lines from ESD, EFT, and lightning.

Features:

- SO-8 Package
- Peak Power – 300 W 8 x 20 μ S
- ESD Rating:
 - IEC 61000-4-2 (ESD) ± 15 kV (air) ± 8 kV (contact)
 - IEC 61000-4-4 (EFT) 40 A (5/50 ns)
 - IEC 61000-4-5 (lightning) 12 A (8/20 μ s)
- UL Flammability Rating of 94 V-0
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications:

- High Speed Communication Line Protection
- Data and I/O Lines
- Microprocessor Based Equipment
- LAN/WAN Equipment
- Servers
- Notebook and Desktop PC
- Serial and Parallel Ports
- Peripherals

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation 8 x 20 μ s @ $T_A = 25^\circ\text{C}$ (Note 1)	P_{pk}	300	W
Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$
Lead Solder Temperature – Maximum 10 Seconds Duration	T_L	260	$^\circ\text{C}$

1. Non-repetitive current pulse 8 x 20 μ S exponential decay waveform

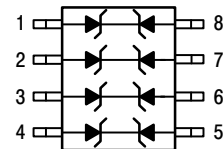


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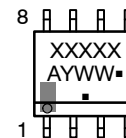
SO-8 VOLTAGE SUPPRESSOR 300 WATTS PEAK POWER

PIN CONFIGURATION AND SCHEMATIC



SO-8
CASE 751

MARKING DIAGRAM



- A = Assembly Location
- Y = Year
- WW = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

SMDA05C Series

SMDA05C ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}	-	-	5.0	V
Reverse Breakdown Voltage @ $I_t = 1.0$ mA	V_{BR}	6.0	-	-	V
Reverse Leakage Current @ $V_{RWM} = 5$ Volts	I_R	N/A	-	20	μ A
Maximum Clamping Voltage @ $I_{PP} = 1.0$ A, 8×20 μ s	V_C	N/A	-	9.8	V
Maximum Clamping Voltage @ $I_{PP} = 5.0$ A, 8×20 μ s	V_C	N/A	-	11	V
Maximum Peak Pulse Current, 8×20 μ s	I_{PP}	-	-	17	A
Junction Capacitance @ $V_R = 0$ V, $f = 1$ MHz	C_J	-	-	350	pF

SMDA12C ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}	-	-	12	V
Reverse Breakdown Voltage @ $I_t = 1.0$ mA	V_{BR}	13.3	-	-	V
Reverse Leakage Current @ $V_{RWM} = 12$ Volts	I_R	N/A	-	1.0	μ A
Maximum Clamping Voltage @ $I_{PP} = 1.0$ A, 8×20 μ s	V_C	N/A	-	19	V
Maximum Clamping Voltage @ $I_{PP} = 5.0$ A, 8×20 μ s	V_C	N/A	-	24	V
Maximum Peak Pulse Current, 8×20 μ s	I_{PP}	-	-	12	A
Junction Capacitance @ $V_R = 0$ V, $f = 1$ MHz	C_J	-	-	120	pF

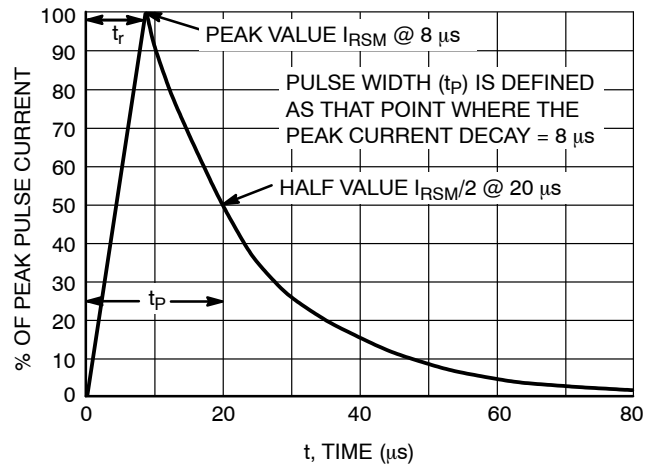
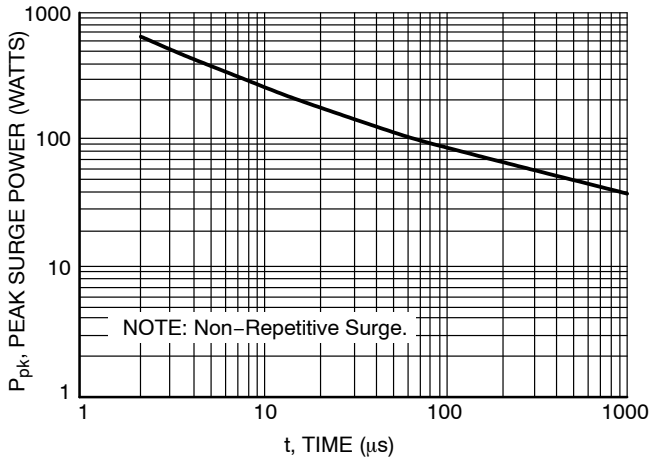
SMDA15C ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}	-	-	15	V
Reverse Breakdown Voltage @ $I_t = 1.0$ mA	V_{BR}	16.7	-	-	V
Reverse Leakage Current @ $V_{RWM} = 15$ Volts	I_R	N/A	-	1.0	μ A
Maximum Clamping Voltage @ $I_{PP} = 1.0$ A, 8×20 μ s	V_C	N/A	-	24	V
Maximum Clamping Voltage @ $I_{PP} = 5.0$ A, 8×20 μ s	V_C	N/A	-	30	V
Maximum Peak Pulse Current, 8×20 μ s	I_{PP}	-	-	10	A
Junction Capacitance @ $V_R = 0$ V, $f = 1$ MHz	C_J	-	-	75	pF

SMDA24C ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}	-	-	24	V
Reverse Breakdown Voltage @ $I_t = 1.0$ mA	V_{BR}	26.7	-	-	V
Reverse Leakage Current @ $V_{RWM} = 24$ Volts	I_R	N/A	-	1.0	μ A
Maximum Clamping Voltage @ $I_{PP} = 1.0$ A, 8×20 μ s	V_C	N/A	-	43	V
Maximum Clamping Voltage @ $I_{PP} = 5.0$ A, 8×20 μ s	V_C	N/A	-	55	V
Maximum Peak Pulse Current, 8×20 μ s	I_{PP}	-	-	5.0	A
Junction Capacitance @ $V_R = 0$ V, $f = 1$ MHz	C_J	-	-	50	pF

SMDA05C Series



ORDERING INFORMATION

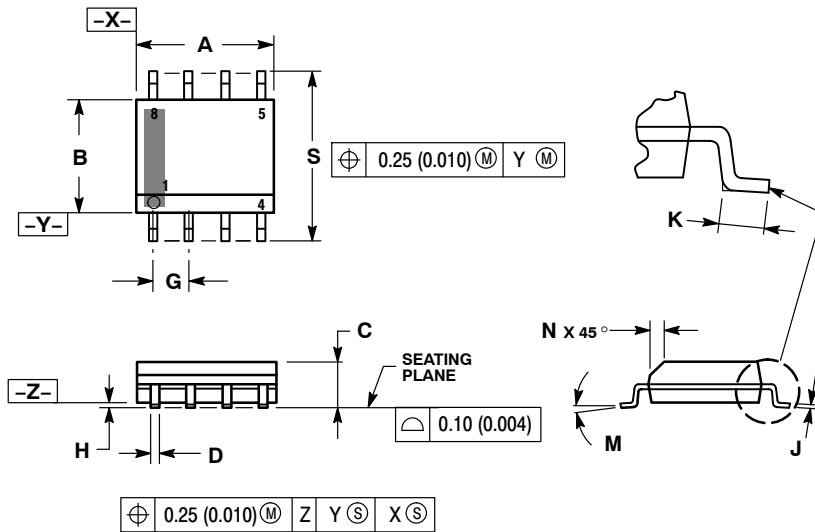
Device	Marking	Package	Shipping†
SMDA05CDR2G	TBD	SO-8 (Pb-Free)	2500 / Tape & Reel
SMDA12CDR2G	TBD	SO-8 (Pb-Free)	2500 / Tape & Reel
SMDA15CDR2G	TBD	SO-8 (Pb-Free)	2500 / Tape & Reel
SMDA24CDR2G	TBD	SO-8 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SMDA05C Series

PACKAGE DIMENSIONS

SOIC-8 NB
CASE 751-07
ISSUE AJ

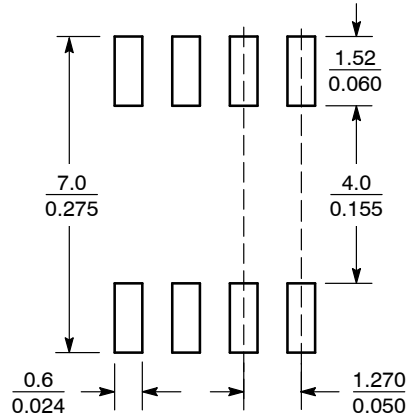


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT*



SCALE 6:1 $\left(\frac{\text{mm}}{\text{inches}} \right)$

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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